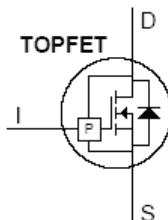
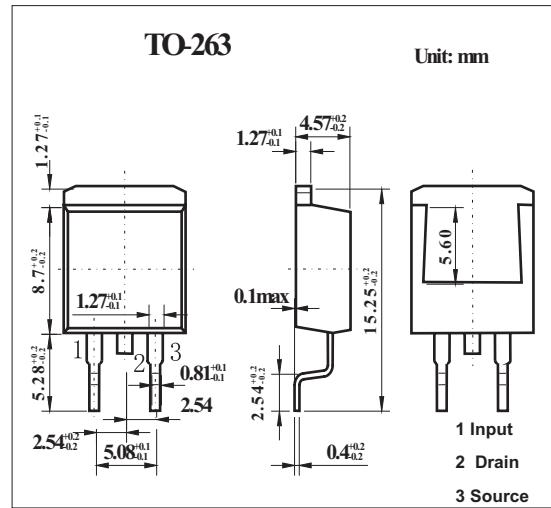


## PowerMOS transistor Logic level TOPFET

### KUK108-50DL

#### ■ Features

- Vertical power DMOS output stage
- Low on-state resistance
- Overload protection against over temperature
- Overload protection against short circuit load
- Latched overload protection reset by input
- 5 V logic compatible input level
- Control of power MOSFET and supply of overload protection circuits derived from input
- Lower operating input current permits direct drive by micro-controller
- ESD protection on input pin
- Overvoltage clamping for turn off of inductive loads



#### ■ Absolute Maximum Ratings Ta = 25°C

Parameter	Symbol	Condition	Rating	Unit
Continuous drain source voltage*1	V <sub>Ds</sub>		50	V
Continuous input voltage	V <sub>IS</sub>		6	V
Continuous drain current	I <sub>D</sub>	T <sub>mb</sub> ≤ 25 °C; V <sub>IS</sub> = 5 V	13.5	A
Continuous drain current	I <sub>D</sub>	T <sub>mb</sub> ≤ 100 °C; V <sub>IS</sub> = 5 V	8.5	A
Repetitive peak on-state drain current	I <sub>DRM</sub>	T <sub>mb</sub> ≤ 25 °C; V <sub>IS</sub> = 5 V	54	A
Total power dissipation	P <sub>D</sub>	T <sub>mb</sub> ≤ 25 °C	40	W
Storage temperature	T <sub>stg</sub>		-55 to +150	°C
Continuous junction temperature*2	T <sub>j</sub>		150	°C
Lead temperature	T <sub>sold</sub>		250	°C
Protection supply voltage*3	V <sub>ISP</sub>		4	V
Protected drain source supply voltage	V <sub>DPP(T)</sub>	V <sub>IS</sub> = 5 V	50	V
Protected drain source supply voltage*4	V <sub>DPP(P)</sub>	V <sub>IS</sub> = 5 V	24	V
Instantaneous overload dissipation	P <sub>DSM</sub>	T <sub>mb</sub> = 25 °C	0.6	kW
Repetitive peak clamping current	I <sub>DRM</sub>	V <sub>IS</sub> = 0 V	15	A
Non-repetitive clamping energy	E <sub>DSM</sub>	T <sub>mb</sub> ≤ 25 °C; I <sub>D</sub> = 15 A; V <sub>DD</sub> ≤ 20 V;	200	mJ
Repetitive clamping energy	E <sub>DRM</sub>	T <sub>mb</sub> ≤ 95 °C; I <sub>D</sub> = 8 A; V <sub>DD</sub> ≤ 20 V; f = 250 Hz	20	mJ
Electrostatic discharge capacitor voltage	V <sub>C</sub>	C = 250 pF; R = 1.5 kΩ	2	kV

**KUK108-50DL****■ Absolute Maximum Ratings Ta = 25°C**

Parameter	Symbol	Condition	Rating	Unit
Junction to mounting base	R <sub>th j-mb</sub>		2.5 to 3.1	K/W
Junction to ambient	R <sub>th j-a</sub>		50	K/W
Continuous forward current	I <sub>s</sub>	T <sub>mb</sub> ≤ 25 °C; V <sub>is</sub> = 0 V	15	A

\*1Prior to the onset of overvoltage clamping. For voltages above this value, safe operation is limited by the overvoltage clamping energy.

\*2A higher T<sub>j</sub> is allowed as an overload condition but at the threshold T<sub>j</sub>(TO) the over temperature trip operates to protect the switch

\*3The input voltage for which the overload protection circuits are functional.

\*4The short circuit load protection is able to save the device providing the instantaneous on-state dissipation is less than the limiting value for PDSM, which is always the case when V<sub>ds</sub> is less than V<sub>DDP(P)</sub> maximum.

**■ Electrical Characteristics Ta = 25°C**

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit	
Drain-source clamping voltage	V <sub>(CL)DSS</sub>	V <sub>is</sub> = 0 V; I <sub>d</sub> = 10 mA	50			V	
Drain-source clamping voltage	V <sub>(CL)DSS</sub>	V <sub>is</sub> = 0 V; I <sub>dM</sub> = 1 A; t <sub>p</sub> ≤ 300 ms; d ≤ 0.01			70	V	
Zero input voltage drain current	I <sub>dss</sub>	V <sub>ds</sub> = 12 V; V <sub>is</sub> = 0 V		0.5	10	μA	
Zero input voltage drain current	I <sub>dss</sub>	V <sub>ds</sub> = 50 V; V <sub>is</sub> = 0 V		1	20	μA	
Zero input voltage drain current	I <sub>dss</sub>	V <sub>ds</sub> = 40 V; V <sub>is</sub> = 0 V; T <sub>j</sub> = 125 °C		10	100	μA	
Drain-source on-state resistance*1	R <sub>Ds(ON)</sub>	V <sub>is</sub> = 5 V; I <sub>dM</sub> = 7.5 A; t <sub>p</sub> ≤ 300 μs; δ ≤ 0.01		85	125	mΩ	
Overload threshold energy	E <sub>Ds(TO)</sub>	V <sub>DD</sub> = 13 V; V <sub>is</sub> = 5 V; L ≤ 10 μH; R <sub>L</sub> = 10 mΩ		0.2		J	
Response time	t <sub>d sc</sub>	V <sub>DD</sub> = 13 V; V <sub>is</sub> = 5 V; L ≤ 10 μH; R <sub>L</sub> = 10 mΩ		0.8		ms	
Drain current*2	I <sub>d(SC)</sub>	V <sub>DD</sub> = 13 V; V <sub>is</sub> = 5 V; L ≤ 10 μH; R <sub>L</sub> = 10 mΩ		25		A	
Peak drain current*3	I <sub>dM(SC)</sub>	V <sub>is</sub> = 5 V; V <sub>DD</sub> = 13 V; L ≤ 10 μH; R <sub>L</sub> = 10 mΩ		60		A	
Threshold junction temperature	T <sub>j(TO)</sub>	V <sub>is</sub> = 5 V; from I <sub>d</sub> ≥ 0.5 A*4	150			°C	
Forward transconductance	g <sub>f</sub>	V <sub>ds</sub> = 10 V; I <sub>dM</sub> = 7.5 A; t <sub>p</sub> ≤ 300 ms; d ≤ 0.01	5	9		s	
Input threshold voltage	V <sub>is(TO)</sub>	V <sub>ds</sub> = 5 V; I <sub>d</sub> = 1 mA	1.0	1.5	2.0	V	
Input supply current	I <sub>is</sub>	V <sub>is</sub> = 5 V	100	200	350	μA	
		V = 4 V			160	270	μA
Protection reset voltage*5	V <sub>isR</sub>	T <sub>j</sub> = 25 °C	2.0	2.6	3.5	V	
		T = 150 °C	1.0				
Input supply current	I <sub>isL</sub>	V <sub>is</sub> = 3.5 V		330	650	μA	
		V <sub>is</sub> = 5 V		240	430	μA	
Input breakdown voltage	V <sub>(BR)IS</sub>	I <sub>i</sub> = 10 mA	6			V	
Input series resistance	R <sub>iG</sub>	T <sub>j</sub> = 25 °C		33		kΩ	
to gate of power MOSFET		T <sub>j</sub> = 150 °C		50		kΩ	
Turn-on delay time	t <sub>d on</sub>	V <sub>DD</sub> = 13 V; V <sub>is</sub> = 5 V		8		μs	
Rise time	t <sub>r</sub>	R <sub>L</sub> = 4 Ω		40		μs	
Turn-off delay time	t <sub>d off</sub>	V <sub>DD</sub> = 13 V; V <sub>is</sub> = 0 V		40		μs	
Fall time	t <sub>f</sub>	R <sub>L</sub> = 4 Ω		35		μs	

## KUK108-50DL

### ■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Testconditons	Min	Typ	Max	Unit
Forward voltage	V <sub>sdo</sub>	I <sub>s</sub> = 15 A; V <sub>ds</sub> = 0 V; t <sub>p</sub> = 300 ms		1.0	1.5	V
Reverse recovery time	t <sub>rr</sub>					
Internal drain inductance	L <sub>d</sub>			2.5		nH
Internal source inductance	L <sub>s</sub>			7.5		nH

\*1Continuous input voltage. The specified pulse width is for the drain current.

\*2Continuous drain-source supply voltage. Pulsed input voltage.

\*3Continuous input voltage. Momentary short circuit load connection. (The higher peak current is due to the effect of capacitance C<sub>gd</sub>).

\*4The over temperature protection feature requires a minimum on-state drain source voltage for correct operation.

The specified minimum I<sub>d</sub> ensures this condition.

\*5The input voltage below which the overload protection circuits will be reset.